



LSE039 R2 Bluetooth Compact Flash Card

General Description

The LSE039 R2 Compact Flash Card is a plug in unit for PDAs and other Compact Flash Host devices running certain Microsoft Windows Platforms.

The LSE039 R2 enables point-to-multipoint communication over Bluetooth.

In addition the Compact Flash Card supports wireless printing in conjunction with the LSE019 Printer Adapter as well as serial port profile printing. Installation and configuration tools for a range of Microsoft Windows PC platforms.

Features

- Bluetooth 1.1 qualified including Software
- Bluetooth 1.1 qualified as Hardware component
- Piconet (Point-to-multipoint) enabled
- Data rates up to 460 kbps
- Integrated antenna

Bluetooth Application Profiles

- Generic Access Profile
- Serial Port Profile
- File Transfer Profile
- Dial-Up Networking Profile
- LAN Access Profile

Supported Applications

- Serial Port Profile Printing⁽¹⁾
- Proprietary Wireless Printing (Requires the LSE019 Printer Adapter)
- Fax⁽¹⁾

OEM Customization Options

- Color and Labeling
- User Interface
- Support for other devices/platforms

Note ⁽¹⁾: Third party software required.

Radio Specifications

| | |
|--------------------------------|---|
| Frequency Range | 2.402 - 2.480GHz, Programmable for Specific National Regulations |
| Supported Specification | Bluetooth 1.1 |
| RF Output Power | 0dBm, Power Class 2 |
| Receiver Sensitivity | Better than -70dBm at 0.1% BER |
| Frequency Spectrum Utilization | Frequency Hopping Spread Spectrum (FHSS) |
| Modulation | Gaussian Frequency Shift Keying (GFSK) |
| Bit-rate | 1 Mbps |
| Antenna | Integrated |
| Regulative Compliance | FCC part 15, UL 1950 (US), ETS 300 328, ETS 300 826, EN 60 950 (Europe) |

Electrical Characteristics

| | |
|---------------------|--|
| Power Supply | 3.3VDC or 5VDC from Flash Card connector |
| Current Consumption | 60mA max. 10mA min. |
| Physical Interface | Type I Compact Flash Card slot. Supports Compact Flash I/O v1.4 |
| LED Indicator | Power On / Data Traffic |

Mechanical Specifications

| | |
|------------|------------------|
| Dimensions | 48 x 43 x 6 (mm) |
| Weight | Approx. 15 (g) |

Environment

| | |
|-----------------------|----------------------|
| Operating Temperature | ±0° C to +55° C |
| Storage Temperature | -20° C to +70° C |
| Humidity | 5-95% non-condensing |

Configuration and Security

| | |
|--|---|
| Supported Operating Systems and Processors | Microsoft Windows PC and Pocket PC on selected processors |
| Installation and configuration tools | Microsoft Windows PC Platforms |
| Firmware upgrade | Via external programming adapter |
| Authentication | Supported |
| Encryption | Supported |
| For latest information: | |

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